

Lonten N-channel 40V, 39A, 7.5mΩ Power MOSFET

Description

These N-Channel enhancement mode power field effect transistors are using split gate trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and with stand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

Features

- 40V,39A, $R_{DS(on),max} = 7.5 m\Omega@V_{GS} = 10V$
- Improved dv/dt capability
- Fast switching
- ♦ 100% EAS Guaranteed
- Green device available

Applications

- Motor Drives
- ◆ UPS
- DC-DC Converter

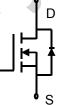
Product Summary

 $\begin{array}{ll} V_{DSS} & 40V \\ R_{DS(on),max} @ V_{GS} {=} 10V & 7.5 m\Omega \\ I_D & 39A \end{array}$

Pin Configuration







N-Channel MOSFET



Absolute Maximum Ratings Tc = 25°C unless otherwise noted				
Parameter	Symbol	Value	Unit	
Drain-Source Voltage	V _{DSS}	40	V	
Continuous drain current (T _C = 25°C)		39	A	
$(T_{C} = 100^{\circ}C)$	l _D	26	A	
Pulsed drain current ¹⁾	I _{DM}	117	A	
Gate-Source voltage	V _{GSS}	±20	V	
Avalanche energy ²⁾	Eas	11	mJ	
Power Dissipation	P _D	24	W	
Storage Temperature Range	T _{STG}	-55 to +150	°C	
Operating Junction Temperature Range	TJ	-55 to +150	°C	

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case	R _{eJC}	5.3	°C/W
Thermal Resistance Junction-to-Ambient	R _{0JA}	60	°C/W



Package Marking and Ordering Information

Device	Device Package	Marking	Units/Reel	
LSGN04R075WB	DFN5X6	04R075WB	5000	

Electrical Characteristics T_J = 25°C unless otherwise noted

Electrical Characteristics	T₃ = 25°C unle	ess otherwise noted				
Parameter	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Static characteristics			•			
Drain-source breakdown voltage	BV _{DSS}	V _{GS} =0 V, I _D =250uA	40			V
Gate threshold voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250uA	1.2	1.7	2.5	V
Drain-source leakage current	I _{DSS}	V _{DS} =40 V, V _{GS} =0V			1	μA
Gate leakage current, Forward	I _{GSSF}	V _{GS} =20 V, V _{DS} =0 V			100	nA
Gate leakage current, Reverse	I _{GSSR}	V _{GS} =-20 V, V _{DS} =0 V			-100	nA
	_	V _{GS} =10 V, I _D =12 A		5.8	7.5	mΩ
Drain-source on-state resistance	R _{DS(on)}	V _{GS} =4.5 V, I _D =10 A	-	8.7	12	mΩ
Dynamic characteristics						'
Input capacitance	Ciss	V 45 V V 0 V		693		
Output capacitance	Coss	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V},$ $V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V},$	<u> </u>	195		pF
Reverse transfer capacitance	C _{rss}	F = IMINZ		39.5		
Turn-on delay time	t _{d(on)}			14.5		
Rise time	tr	V_{DD} = 15V, V_{GS} =10V, I_{D} = 12A R_{G} =3.3 Ω		6.1		ns
Turn-off delay time	t _{d(off)}			20.5		1
Fall time	t _f			11.6		
Gate resistance	Rg	V _{GS} =0 V,V _{DS} =0 V, F=1MHz		1.8		Ω
Gate charge characteristics						•
Gate to source charge	Q _{gs}	V 00V I 40A		3.1		
Gate to drain charge	Q_{gd}	V _{DS} =20V, I _D =12A,		1.3		nC
Gate charge total	Qg	- V _{GS} = 10 V		15.5		
Drain-Source diode characteristic	s and Maxi	mum Ratings				
Continuous Source Current	Is				20	Α
Pulsed Source Current ³⁾	I _{SM}				60	Α
Diode Forward Voltage	V _{SD}	V _{GS} =0V, I _S =12A, T _J =25°C			1.2	V
		•				

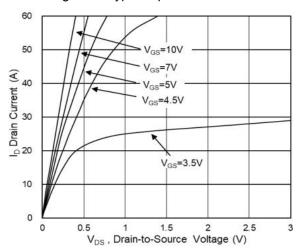
Notes

- 1: Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2: V_{DD} =25V, V_{GS} =10V, L=0.1mH, I_{AS} =15A, Starting T_J =25 $^{\circ}$ C.
- 3: Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.



Electrical Characteristics Diagrams

Figure 1. Typ. Output Characteristics



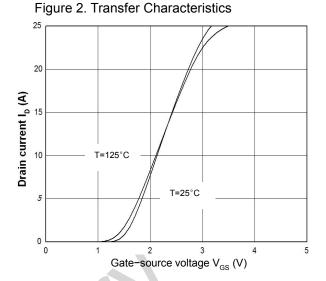


Figure 3. Capacitance Characteristics

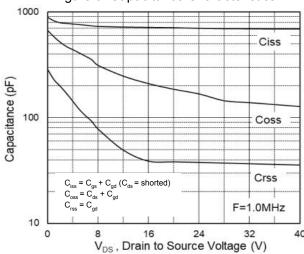


Figure 4. Gate Charge Waveform

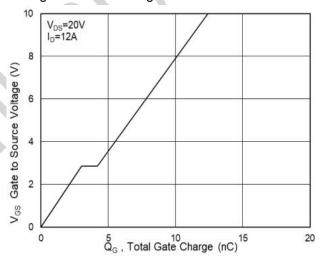


Figure 5. Body-Diode Characteristics

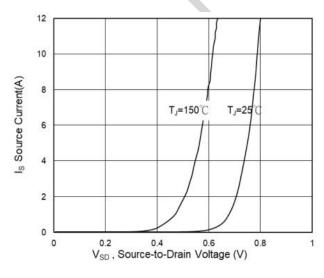


Figure 6. Rdson-Drain Current

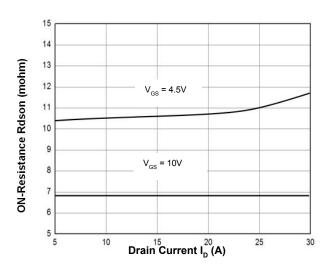




Figure 7. Rdson-Junction Temperature

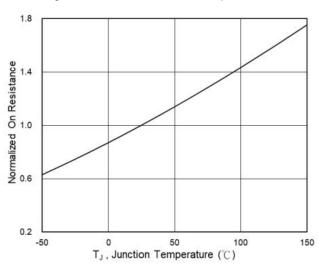


Figure 8. V_{GS(th)}-Junction Temperature

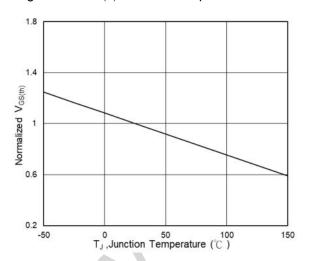


Figure 9. On-Resistance vs. Gate-to-Source voltage

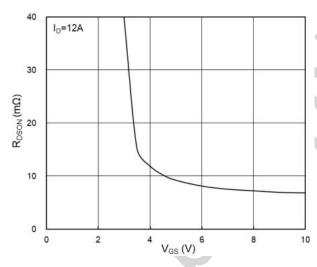


Figure 10: Safe Operating Area

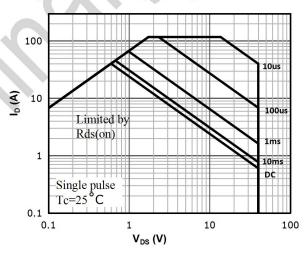
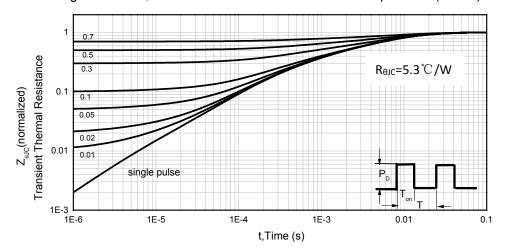


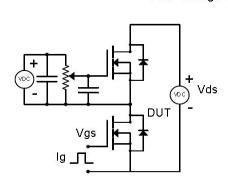
Figure 11. Normalized Maximum Transient Thermal Impedance (RthJC)

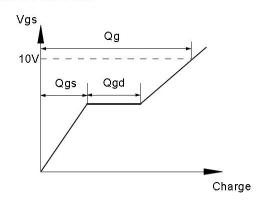




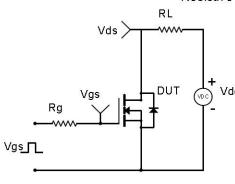
Test Circuit & Waveforms

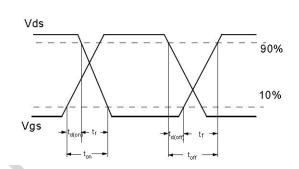
Gate Charge Test Circuit & Waveform



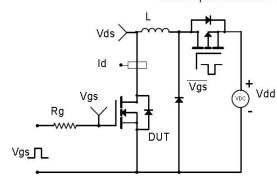


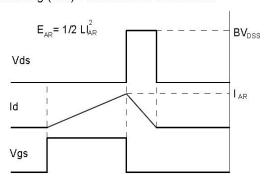
Resistive Switching Test Circuit & Waveforms



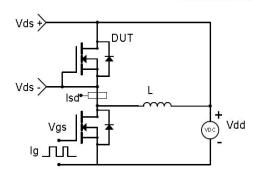


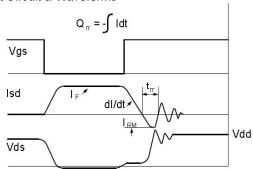
Unclamped Inductive Switching (UIS) Test Circuit & Waveforms





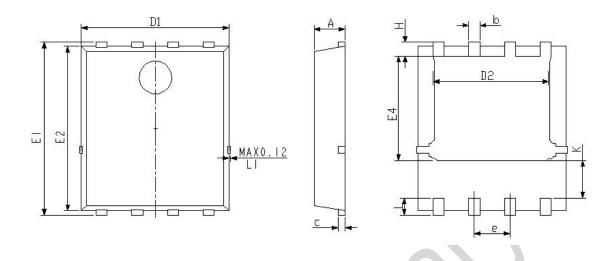
Diode Recovery Test Circuit & Waveforms







Mechanical Dimensions for DFN5×6



DIMENSIONS	DIMENSIONS IN MILLITMETERS		DIMENSIONS IN INCHE		
SYMBOL	MIN	MAX	MIN	MAX	
A	0.85	1. 20	0.033	0.047	
b	0.30	0.51	0.012	0.020	
С	0. 15	0. 35	0.006	0.014	
D1	4. 80	5. 40	0. 189	0. 213	
D2	3. 70	4. 55	0. 146	0.179	
E1	5. 95	6. 35	0. 234	0. 250	
E2	5. 45	6.06	0. 215	0. 239	
E4	3. 30	3. 92	0. 130	0. 154	
е	1. 27BSC		0. 05BSC		
L	0.3	0.71	0.012	0.028	
Н	0.38	0.71	0.015	0.028	
K	1. 15	1. 45	0.045	0.057	



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